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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I <sup>2</sup> C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	84
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	63K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64179dfb-ub">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64179dfb-ub</a>

**Table 1.4 Performance Overview for the 100-pin Package (2/2)**

Unit	Function	Explanation
Timer	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse-width modulation (PWM) mode Two-phase pulse signal processing in event counter mode (two-phase encoder input) × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse frequency measurement mode, pulse-width measurement mode
	Three-phase motor control timer	Three-phase motor control timer × 1 (timers A1, A2, A4, and B2 used) 8-bit programmable dead time timer
Serial Interface	UART0 to UART8	Asynchronous/synchronous serial interface × 9 channels • I <sup>2</sup> C-bus (UART0 to UART6) • Special mode 2 (UART0 to UART6) • IEBus (optional <sup>(1)</sup> ) (UART0 to UART6)
A/D Converter		10-bit resolution × 26 channels Sample and hold functionality integrated
D/A Converter		8-bit resolution × 2
CRC Calculator		CRC-CCITT ( $X^{16} + X^{12} + X^5 + 1$ )
X-Y Converter		16 bits × 16 bits
Intelligent I/O		Time measurement (input capture): 16 bits × 16 Waveform generation (output compare): 16 bits × 19 Serial interface: Variable-length synchronous serial I/O mode, IEBus mode (optional <sup>(1)</sup> )
Multi-master I <sup>2</sup> C-bus Interface		1 channel
CAN Module		1 channel CAN functionality compliant with ISO 11898-1 32 mailboxes
Flash Memory		Programming and erasure supply voltage: VCC = 3.0 to 5.5 V Minimum endurance: 1,000 program/erase cycles Security protection: ROM code protect, ID code protect Debugging: On-chip debug, on-board flash programming
Operating Frequency/Supply Voltage		64 MHz (high speed version)/VCC = 3.0 to 5.5 V 50 MHz (normal speed version)/VCC = 3.0 to 5.5 V
Operating Temperature		-20°C to 85°C (N version) -40°C to 85°C (D version) -40°C to 85°C (P version)
Current Consumption		45 mA (VCC = 5.0 V, f(CPU) = 64 MHz) 35 mA (VCC = 5.0 V, f(CPU) = 50 MHz) 8 μA (VCC = 3.3 V, f(XCIN) = 32.768 kHz, in wait mode)
Package		100-pin plastic molded LQFP (PLQP0100KB-A)

Note:

1. Contact a Renesas Electronics sales office to use the optional features.

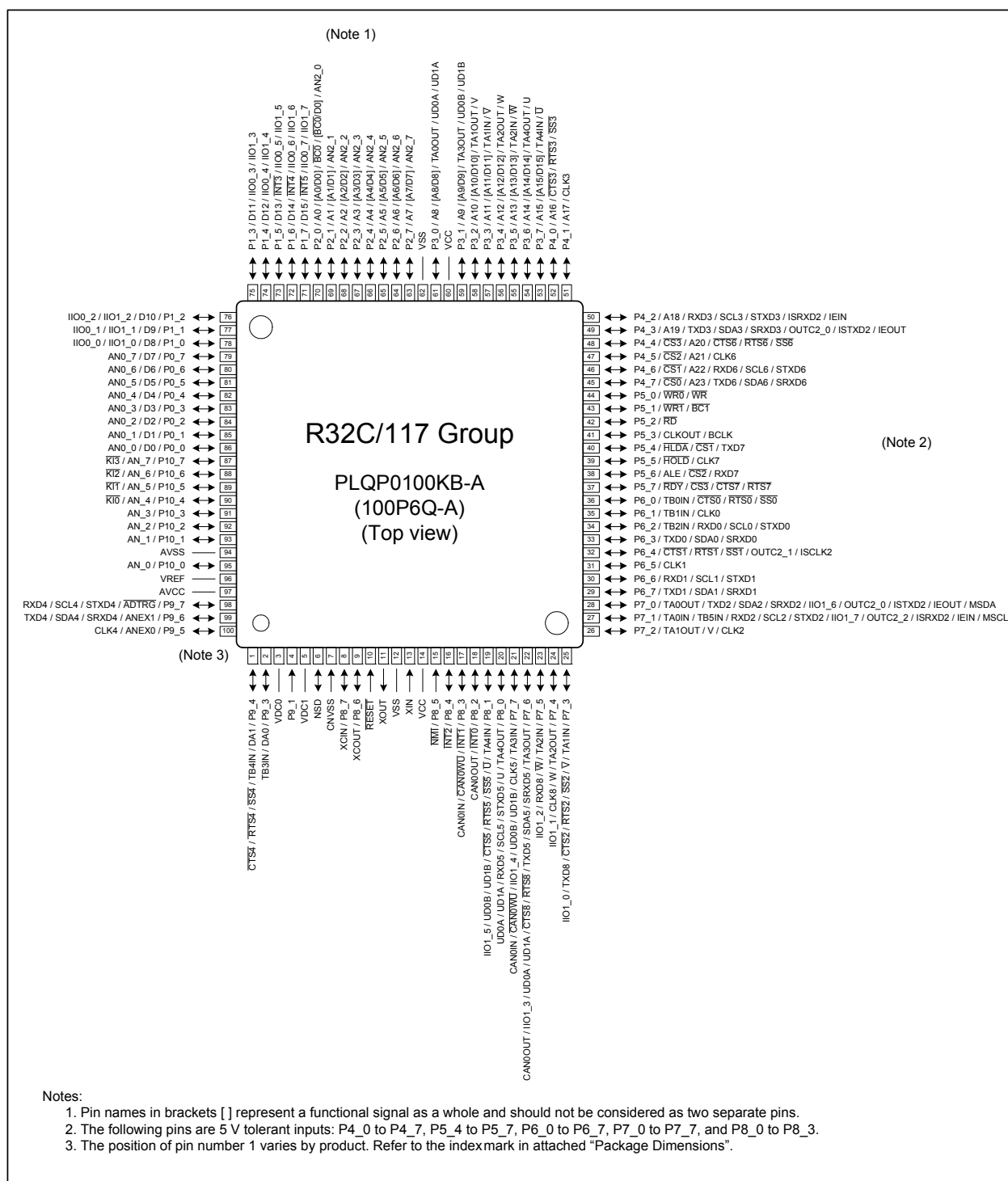


Figure 1.4 Pin Assignment for the 100-pin Package (top view)

**Table 1.18 Pin Specifications**

Pin Names	Package		Selectable Functions		5 V Tolerant Input (3)
	144-pin	100-pin	Pull-up resistor (1)	N-channel open drain (2)	
P0_0 to P0_7	✓	✓	✓		
P1_0 to P1_7	✓	✓	✓		
P2_0 to P2_7	✓	✓	✓		
P3_0 to P3_7	✓	✓	✓		
P4_0 to P4_7	✓	✓		✓	✓
P5_0 to P5_3	✓	✓	✓		
P5_4 to P5_7	✓	✓		✓	✓
P6_0 to P6_7	✓	✓		✓	✓
P7_0 to P7_7	✓	✓		✓	✓
P8_0 to P8_3	✓	✓		✓	✓
P8_4, P8_6, P8_7	✓	✓	✓		
P9_0 to P9_3 (144-pin)	✓		✓	✓	
P9_1, P9_3 (100-pin)		✓	✓		
P9_4 to P9_7	✓	✓	✓	✓	
P10_0 to P10_7	✓	✓	✓		
P11_0 to P11_3	✓		✓	✓	
P11_4	✓		✓		
P12_0 to P12_3	✓		✓	✓	
P12_4 to P12_7	✓		✓		
P13_0 to P13_7	✓		✓		
P14_1, P14_3	✓		✓		
P14_4 to P14_6	✓		✓		
P15_0 to P15_7	✓		✓	✓	

Notes:

1. Pull-up resistors are selected for the following 4-pin units: Pi\_0 to Pi\_3 and Pi\_4 to Pi\_7 (i = 0 to 15); however, they are enabled only for the input pins.
2. N-channel open drain output can be enabled on the applicable pins on a discrete pin basis.
3. 5 V tolerant input is enabled when an applicable pin is set as an input port. When it is set as an I/O port, to enable 5 V tolerant input, this pin should be set as N-channel open drain output.

**2.1.8.5 Register Bank Select Flag (B flag)**

This flag selects a register bank. It indicates 0 when register bank 0 is selected, and 1 when register bank 1 is selected.

**2.1.8.6 Overflow Flag (O flag)**

This flag becomes 1 when the result of an operation overflows; otherwise it is 0.

**2.1.8.7 Interrupt Enable Flag (I flag)**

This flag enables maskable interrupts. To disable maskable interrupts, set this flag to 0. To enable them, set this flag to 1. When an interrupt is accepted, the flag becomes 0.

**2.1.8.8 Stack Pointer Select Flag (U flag)**

To select the interrupt stack pointer (ISP), set this flag to 0. To select the user stack pointer (USP), set this flag to 1.

It becomes 0 when a hardware interrupt is accepted or when an INT instruction designated by a software interrupt number from 0 to 127 is executed.

**2.1.8.9 Floating-point Underflow Flag (FU flag)**

This flag becomes 1 when an underflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

**2.1.8.10 Floating-point Overflow Flag (FO flag)**

This flag becomes 1 when an overflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

**2.1.8.11 Processor Interrupt Priority Level (IPL)**

The processor interrupt priority level (IPL), consisting of 3 bits, selects a processor interrupt priority level from level 0 to 7. An interrupt is enabled when the interrupt request level is higher than the selected IPL.

When the processor interrupt priority level (IPL) is set to 111b (level 7), all interrupts are disabled.

**2.1.8.12 Fixed-point Radix Point Designation Bit (DP bit)**

This bit designates the radix point. It also specifies which portion of the fixed-point multiplication result to extract. It is used for the MULX instruction.

**2.1.8.13 Floating-point Rounding Mode (RND)**

The 2-bit floating-point rounding mode selects a rounding mode for floating-point calculation results.

**2.1.8.14 Reserved**

Only set this bit to 0. The read value is undefined.

**Table 4.8 SFR List (8)**

Address	Register	Symbol	Reset Value
000170h	Group 2 IEBus Address Register	IEAR	XXXXh
000171h			
000172h	Group 2 IEBus Control Register	IECR	00XX X000b
000173h	Group 2 IEBus Transmit Interrupt Source Detect Register	IETIF	XXX0 0000b
000174h	Group 2 IEBus Receive Interrupt Source Detect Register	IERIF	XXX0 0000b
000175h			
000176h			
000177h			
000178h			
000179h			
00017Ah			
00017Bh			
00017Ch			
00017Dh			
00017Eh			
00017Fh			
000180h	Group 0 Time Measurement/Waveform Generation Register 0	G0TM0/G0PO0	XXXXh
000181h			
000182h	Group 0 Time Measurement/Waveform Generation Register 1	G0TM1/G0PO1	XXXXh
000183h			
000184h	Group 0 Time Measurement/Waveform Generation Register 2	G0TM2/G0PO2	XXXXh
000185h			
000186h	Group 0 Time Measurement/Waveform Generation Register 3	G0TM3/G0PO3	XXXXh
000187h			
000188h	Group 0 Time Measurement/Waveform Generation Register 4	G0TM4/G0PO4	XXXXh
000189h			
00018Ah	Group 0 Time Measurement/Waveform Generation Register 5	G0TM5/G0PO5	XXXXh
00018Bh			
00018Ch	Group 0 Time Measurement/Waveform Generation Register 6	G0TM6/G0PO6	XXXXh
00018Dh			
00018Eh	Group 0 Time Measurement/Waveform Generation Register 7	G0TM7/G0PO7	XXXXh
00018Fh			
000190h	Group 0 Waveform Generation Control Register 0	G0POCR0	0000 X000b
000191h	Group 0 Waveform Generation Control Register 1	G0POCR1	0X00 X000b
000192h	Group 0 Waveform Generation Control Register 2	G0POCR2	0X00 X000b
000193h	Group 0 Waveform Generation Control Register 3	G0POCR3	0X00 X000b
000194h	Group 0 Waveform Generation Control Register 4	G0POCR4	0X00 X000b
000195h	Group 0 Waveform Generation Control Register 5	G0POCR5	0X00 X000b
000196h	Group 0 Waveform Generation Control Register 6	G0POCR6	0X00 X000b
000197h	Group 0 Waveform Generation Control Register 7	G0POCR7	0X00 X000b
000198h	Group 0 Time Measurement Control Register 0	G0TMCR0	00h
000199h	Group 0 Time Measurement Control Register 1	G0TMCR1	00h
00019Ah	Group 0 Time Measurement Control Register 2	G0TMCR2	00h
00019Bh	Group 0 Time Measurement Control Register 3	G0TMCR3	00h
00019Ch	Group 0 Time Measurement Control Register 4	G0TMCR4	00h
00019Dh	Group 0 Time Measurement Control Register 5	G0TMCR5	00h
00019Eh	Group 0 Time Measurement Control Register 6	G0TMCR6	00h
00019Fh	Group 0 Time Measurement Control Register 7	G0TMCR7	00h

X: Undefined

Blanks are reserved. No access is allowed.

**Table 4.9 SFR List (9)**

Address	Register	Symbol	Reset Value
0001A0h	Group 0 Base Timer Register	G0BT	XXXXh
0001A1h			
0001A2h	Group 0 Base Timer Control Register 0	G0BCR0	0000 0000b
0001A3h	Group 0 Base Timer Control Register 1	G0BCR1	0000 0000b
0001A4h	Group 0 Time Measurement Prescaler Register 6	G0TPR6	00h
0001A5h	Group 0 Time Measurement Prescaler Register 7	G0TPR7	00h
0001A6h	Group 0 Function Enable Register	G0FE	00h
0001A7h	Group 0 Function Select Register	G0FS	00h
0001A8h			
0001A9h			
0001AAh			
0001ABh			
0001ACh			
0001ADh			
0001AEh			
0001AFh			
0001B0h			
0001B1h			
0001B2h			
0001B3h			
0001B4h			
0001B5h			
0001B6h			
0001B7h			
0001B8h			
0001B9h			
0001BAh			
0001BBh			
0001BCh			
0001BDh			
0001BEh			
0001BFh			
0001C0h			
0001C1h			
0001C2h			
0001C3h			
0001C4h	UART5 Special Mode Register 4	U5SMR4	00h
0001C5h	UART5 Special Mode Register 3	U5SMR3	00h
0001C6h	UART5 Special Mode Register 2	U5SMR2	00h
0001C7h	UART5 Special Mode Register	U5SMR	00h
0001C8h	UART5 Transmit/Receive Mode Register	U5MR	00h
0001C9h	UART5 Bit Rate Register	U5BRG	XXh
0001CAh	UART5 Transmit Buffer Register	U5TB	XXXXh
0001CBh			
0001CCh	UART5 Transmit/Receive Control Register 0	U5C0	0000 1000b
0001CDh	UART5 Transmit/Receive Control Register 1	U5C1	0000 0010b
0001CEh	UART5 Receive Buffer Register	U5RB	XXXXh
0001CFh			

X: Undefined

Blanks are reserved. No access is allowed.

**Table 4.18 SFR List (18)**

Address	Register	Symbol	Reset Value
040000h	Flash Memory Control Register 0	FMR0	0X01 XX00b
040001h	Flash Memory Status Register 0	FMSR0	1000 0000b
040002h			
040003h			
040004h			
040005h			
040006h			
040007h			
040008h	Flash Register Protection Unlock Register 0	FPR0	00h
040009h	Flash Memory Control Register 1	FMR1	0000 0010b
04000Ah	Block Protect Bit Monitor Register 0	FBPM0	??X? ???b (1)
04000Bh	Block Protect Bit Monitor Register 1	FBPM1	XXX? ???b (1)
04000Ch			
04000Dh			
04000Eh			
04000Fh			
040010h			
040011h	Block Protect Bit Monitor Register 2	FBPM2	???? ???b (1)
040012h			
040013h			
040014h			
040015h			
040016h			
040017h			
040018h			
040019h			
04001Ah			
04001Bh			
04001Ch			
04001Dh			
04001Eh			
04001Fh			
040020h	PLL Control Register 0	PLC0	0000 0001b
040021h	PLL Control Register 1	PLC1	0001 1111b
040022h			
040023h			
040024h			
040025h			
040026h			
040027h			
040028h			
040029h			
04002Ah			
04002Bh			
04002Ch			
04002Dh			
04002Eh			
04002Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Note:

1. The reset value reflects the value of the protect bit for each block in the flash memory.



**Table 4.28 SFR List (28)**

Address	Register	Symbol	Reset Value
047C60h	CAN0 Mailbox 6: Message Identifier	C0MB6	XXXX XXXXh
047C61h			
047C62h			
047C63h			
047C64h			
047C65h	CAN0 Mailbox 6: Data Length		XXh
047C66h	CAN0 Mailbox 6: Data Field		XXXX XXXX XXXX XXXXh
047C67h			
047C68h			
047C69h			
047C6Ah			
047C6Bh			
047C6Ch			
047C6Dh			
047C6Eh	CAN0 Mailbox 6: Time Stamp		XXXXh
047C6Fh			
047C70h	CAN0 Mailbox 7: Message Identifier	C0MB7	XXXX XXXXh
047C71h			
047C72h			
047C73h			
047C74h			
047C75h	CAN0 Mailbox 7: Data Length		XXh
047C76h	CAN0 Mailbox 7: Data Field		XXXX XXXX XXXX XXXXh
047C77h			
047C78h			
047C79h			
047C7Ah			
047C7Bh			
047C7Ch			
047C7Dh			
047C7Eh	CAN0 Mailbox 7: Time Stamp		XXXXh
047C7Fh			
047C80h	CAN0 Mailbox 8: Message Identifier	C0MB8	XXXX XXXXh
047C81h			
047C82h			
047C83h			
047C84h			
047C85h	CAN0 Mailbox 8: Data Length		XXh
047C86h	CAN0 Mailbox 8: Data Field		XXXX XXXX XXXX XXXXh
047C87h			
047C88h			
047C89h			
047C8Ah			
047C8Bh			
047C8Ch			
047C8Dh			
047C8Eh	CAN0 Mailbox 8: Time Stamp		XXXXh
047C8Fh			

X: Undefined

Blanks are reserved. No access is allowed.

**Table 4.36 SFR List (36)**

Address	Register	Symbol	Reset Value
047DE0h	CAN0 Mailbox 30: Message Identifier	C0MB30	XXXX XXXXh
047DE1h			
047DE2h			
047DE3h			
047DE4h			
047DE5h	CAN0 Mailbox 30: Data Length		XXh
047DE6h	CAN0 Mailbox 30: Data Field		XXXX XXXX XXXX XXXXh
047DE7h			
047DE8h			
047DE9h			
047DEAh			
047DEBh			
047DECh			
047DEDh			
047DEEh	CAN0 Mailbox 30: Time Stamp	XXXXh	
047DEFh			
047DF0h	CAN0 Mailbox 31: Message Identifier	C0MB31	XXXX XXXXh
047DF1h			
047DF2h			
047DF3h			
047DF4h			
047DF5h	CAN0 Mailbox 31: Data Length		XXh
047DF6h	CAN0 Mailbox 31: Data Field		XXXX XXXX XXXX XXXXh
047DF7h			
047DF8h			
047DF9h			
047DFAh			
047DFBh			
047DFCh			
047DFDh			
047DFEh	CAN0 Mailbox 31: Time Stamp	XXXXh	
047DFFh			
047E00h	CAN0 Mask Register 0	C0MKR0	XXXX XXXXh
047E01h			
047E02h			
047E03h			
047E04h	CAN0 Mask Register 1	C0MKR1	XXXX XXXXh
047E05h			
047E06h			
047E07h			
047E08h	CAN0 Mask Register 2	C0MKR2	XXXX XXXXh
047E09h			
047E0Ah			
047E0Bh			
047E0Ch	CAN0 Mask Register 3	C0MKR3	XXXX XXXXh
047E0Dh			
047E0Eh			
047E0Fh			

X: Undefined

Blanks are reserved. No access is allowed.

**Table 5.3 Operating Conditions (2/5)**  
**( $V_{CC} = 3.0$  to  $5.5$  V,  $V_{SS} = 0$  V, and  $T_a = T_{opr}$ , unless otherwise noted) <sup>(1)</sup>**

Symbol	Characteristic		Value (2)			Unit
			Min.	Typ.	Max.	
$C_{VDC}$	Decoupling capacitance for voltage regulator	Inter-pin voltage: 1.5 V	2.4		10.0	$\mu F$

Notes:

1. The device is operationally guaranteed under these operating conditions.
2. This value should be met with due consideration to the following conditions: operating temperature, DC bias, aging, etc.

$$V_{CC} = 5\text{ V}$$

**Table 5.15 Electrical Characteristics (1/3)**

( $V_{CC} = 4.2$  to  $5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ ,  $T_a = T_{opr}$ , and  $f_{(CPU)} = 64\text{ MHz}$ , unless otherwise noted)

Symbol	Characteristic		Measurement Condition	Value			Unit
				Min.	Typ.	Max.	
$V_{OH}$	High level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OH} = -5\text{ mA}$	$V_{CC} - 2.0$		$V_{CC}$	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OH} = -200\text{ }\mu\text{A}$	$V_{CC} - 0.3$		$V_{CC}$	V
$V_{OL}$	Low level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OL} = 5\text{ mA}$			2.0	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OL} = 200\text{ }\mu\text{A}$			0.45	V

Note:

- Ports P9\_0, P9\_2, and P11 to P15 are available in the 144-pin package only. Port P9\_1 is designated as input pin in the 100-pin package.

$$V_{CC} = 5\text{ V}$$

Timing Requirements ( $V_{CC} = 4.2$  to  $5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ , and  $T_a = T_{opr}$ , unless otherwise noted)

**Table 5.30 Serial Interface**

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(CK)}$	CLKi input clock cycle time	200		ns
$t_{W(CKH)}$	CLKi input high level pulse width	80		ns
$t_{W(CKL)}$	CLKi input low level pulse width	80		ns
$t_{Su(D-C)}$	RXD <sub>i</sub> input setup time	80		ns
$t_{h(C-D)}$	RXD <sub>i</sub> input hold time	90		ns

**Table 5.31 A/D Trigger Input**

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{W(ADH)}$	ADTRG input high level pulse width Hardware trigger input high level pulse width	$\frac{3}{\phi_{AD}}$		ns
$t_{W(ADL)}$	ADTRG input low level pulse width Hardware trigger input high level pulse width	125		ns

**Table 5.32 External Interrupt  $\overline{INT}_i$  Input**

Symbol	Characteristic		Value		Unit
			Min.	Max.	
$t_{W(INH)}$	$\overline{INT}_i$ input high level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns
$t_{W(INL)}$	$\overline{INT}_i$ input low level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns

**Table 5.33 Intelligent I/O**

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(ISCLK2)}$	ISCLK2 input clock cycle time	600		ns
$t_{W(ISCLK2H)}$	ISCLK2 input high level pulse width	270		ns
$t_{W(ISCLK2L)}$	ISCLK2 input low level pulse width	270		ns
$t_{Su(RXD-ISCLK2)}$	ISRXD2 input setup time	150		ns
$t_{h(ISCLK2-RXD)}$	ISRXD2 input hold time	100		ns

$$V_{CC} = 5 \text{ V}$$

Switching Characteristics ( $V_{CC} = 4.2$  to  $5.5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , and  $T_a = T_{opr}$ , unless otherwise noted)

**Table 5.37 Serial Interface**

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

**Table 5.38 Intelligent I/O**

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISCLK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISCLK2-RXD)}$	ISTXD2 output hold time		0		ns

**Table 5.39 Multi-master I<sup>2</sup>C-bus Interface (standard-mode)**

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{C(\phi IIC)} - 120$	$52 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{C(\phi IIC)} + 40$	$52 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

**Table 5.40 Multi-master I<sup>2</sup>C-bus Interface (fast-mode)**

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{C(\phi IIC)} - 120$	$26 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{C(\phi IIC)} + 40$	$26 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

Note:

1. External circuits are required to satisfy the I<sup>2</sup>C-bus specification.

$$V_{CC} = 3.3 \text{ V}$$

**Table 5.41 Electrical Characteristics (1/3) ( $V_{CC} = 3.0$  to  $3.6 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ ,  $T_a = T_{opr}$ , and  $f_{(CPU)} = 64 \text{ MHz}$ , unless otherwise noted)**

Symbol	Characteristic		Measurement Condition	Value			Unit
				Min.	Typ.	Max.	
$V_{OH}$	High level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 <sup>(1)</sup>	$I_{OH} = -1 \text{ mA}$	$V_{CC} - 0.6$		$V_{CC}$	V
$V_{OL}$	Low level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 <sup>(1)</sup>	$I_{OL} = 1 \text{ mA}$			0.5	V

Note:

1. Ports P9\_0, P9\_2, and P11 to P15 are available in the 144-pin package only. Port P9\_1 is designated as input pin in the 100-pin package.

$$V_{CC} = 3.3 \text{ V}$$

**Table 5.43 Electrical Characteristics (3/3)****( $V_{CC} = 3.0$  to  $3.6 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , and  $T_a = T_{opr}$ , unless otherwise noted)**

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
$I_{CC}$	Power supply current	In single-chip mode, output pins are left open and others are connected to $V_{SS}$				
		$f_{(CPU)} = 64 \text{ MHz}$ , $f_{(BCLK)} = 32 \text{ MHz}$ , $f_{(XIN)} = 8 \text{ MHz}$ , Active: XIN, PLL, Stopped: XCIN, OCO		40	55	mA
		XIN-XOUT Drive strength: low		32	45	mA
		XCIN-XCOUT Drive strength: low				
		$f_{(CPU)} = f_{SO(PLL)}/24 \text{ MHz}$ , Active: PLL (self-oscillation), Stopped: XIN, XCIN, OCO		9		mA
		$f_{(CPU)} = f_{(BCLK)} = f_{(XIN)}/256 \text{ MHz}$ , $f_{(XIN)} = 8 \text{ MHz}$ , Active: XIN, Stopped: PLL, XCIN, OCO		670		$\mu\text{A}$
		$f_{(CPU)} = f_{(BCLK)} = 32.768 \text{ kHz}$ , Active: XCIN, Stopped: XIN, PLL, OCO, Main regulator: shutdown		180		$\mu\text{A}$
		$f_{(CPU)} = f_{(BCLK)} = f_{(OCO)}/4 \text{ kHz}$ , Active: OCO, Stopped: XIN, PLL, XCIN, Main regulator: shutdown		190		$\mu\text{A}$
		$f_{(CPU)} = f_{(BCLK)} = f_{(XIN)}/256 \text{ MHz}$ , $f_{(XIN)} = 8 \text{ MHz}$ , Active: XIN, Stopped: PLL, XCIN, OCO, $T_a = 25^\circ\text{C}$ , Wait mode		500	900	$\mu\text{A}$
		$f_{(CPU)} = f_{(BCLK)} = 32.768 \text{ kHz}$ , Active: XCIN, Stopped: XIN, PLL, OCO, Main regulator: shutdown, $T_a = 25^\circ\text{C}$ , Wait mode		8	140	$\mu\text{A}$
		$f_{(CPU)} = f_{(BCLK)} = f_{(OCO)}/4 \text{ kHz}$ , Active: OCO, Stopped: XIN, PLL, XCIN, Main regulator: shutdown, $T_a = 25^\circ\text{C}$ , Wait mode		10	150	$\mu\text{A}$
		Stopped: all clocks, Main regulator: shutdown, $T_a = 25^\circ\text{C}$		5	70	$\mu\text{A}$



$$V_{CC} = 3.3 \text{ V}$$

**Table 5.44 A/D Conversion Characteristics** ( $V_{CC} = AV_{CC} = V_{REF} = 3.0 \text{ to } 3.6 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = T_{opr}$ , and  $f_{(BCLK)} = 32 \text{ MHz}$ , unless otherwise noted)

Symbol	Characteristic	Measurement Condition		Value			Unit
				Min.	Typ.	Max.	
—	Resolution	V <sub>REF</sub> = V <sub>CC</sub>				10	Bits
—	Absolute error	V <sub>REF</sub> = V <sub>CC</sub> = 3.3 V	AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 <sup>(1)</sup>			±5	LSB
			External op-amp connection mode			±7	LSB
INL	Integral non-linearity error	V <sub>REF</sub> = V <sub>CC</sub> = 3.3 V	AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 <sup>(1)</sup>			±5	LSB
			External op-amp connection mode			±7	LSB
DNL	Differential non- linearity error	V <sub>REF</sub> = V <sub>CC</sub> = 3.3 V				±1	LSB
—	Offset error					±3	LSB
—	Gain error					±3	LSB
R <sub>LADDER</sub>	Resistor ladder	V <sub>REF</sub> = V <sub>CC</sub>		4		20	kΩ
t <sub>CONV</sub>	Conversion time (10 bits)	φ <sub>AD</sub> = 10 MHz, with sample and hold function		3.3			μs
t <sub>CONV</sub>	Conversion time (8 bits)	φ <sub>AD</sub> = 10 MHz, with sample and hold function		2.8			μs
t <sub>SAMP</sub>	Sampling time	φ <sub>AD</sub> = 10 MHz		0.3			μs
V <sub>IA</sub>	Analog input voltage			0		V <sub>REF</sub>	V
φ <sub>AD</sub>	Operating clock frequency	Without sample and hold function		0.25		10	MHz
		With sample and hold function		1		10	MHz

Note:

1. Pins AN15\_0 to AN15\_7 are available in the 144-pin package only.

$$V_{CC} = 3.3 \text{ V}$$

Timing Requirements ( $V_{CC} = 3.0$  to  $3.6 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ , and  $T_a = T_{opr}$ , unless otherwise noted)

**Table 5.46 External Clock Input**

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(X)}$	External clock input period	62.5	250	ns
$t_{W(XH)}$	External clock input high level pulse width	25		ns
$t_{W(XL)}$	External clock input low level pulse width	25		ns
$t_{r(X)}$	External clock input rise time		5	ns
$t_{f(X)}$	External clock input fall time		5	ns
$t_W / t_C$	External clock input duty	40	60	%

**Table 5.47 External Bus Timing**

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{su(D-R)}$	Data setup time before read	40		ns
$t_{h(R-D)}$	Data hold time after read	0		ns
$t_{dis(R-D)}$	Data disable time after read		$0.5 \times t_{C(Base)} + 10$	ns

Revision History	R32C/117 Group Datasheet
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Rev.	Date	Description	
		Page	Summary
1.00	Nov 19, 2009	—	Initial release
1.01	Mar 11, 2010	—	Second edition released
		—	• Added “128 KB/20KB” and “256KB/20KB” for ROM/RAM capacity
1.10	Jun 23, 2010	—	Third edition released
		—	This manual in general • Applied new Renesas templates and formats to the manual • Changed company name to “Renesas Electronics Corporation” and changed related descriptions due to business merger of Renesas Technology Corporation and NEC Electronics Corporation (under Chapters 1 and 5) • Added specifications of 64 MHz version
		3, 5	<b>Chapter 1. Overview</b> • Deleted Note 1 from <b>Tables 1.2 and 1.4</b>
		6	• Completed “under development” phase of part number R5F6417BDFB in <b>Table 1.5</b>
		11	• Deleted Note 4 from <b>Figure 1.2</b>
		21	• Modified expression “fC” in <b>Table 1.16</b> to “low speed clocks”
		36, 39	<b>Chapter 4. SFRs</b> • Changed register name “Group i Timer Measurement Prescaler Register” in <b>Tables 4.6 and 4.9</b> to “Group i Time Measurement Prescaler Register”
		41	• Modified expression “XY Control Register” in <b>Table 4.11</b> to “X-Y Control Register”
		43	• Changed register name “UART2 Transmission/Receive Mode Register” in <b>Table 4.13</b> to “UART2 Transmit/Receive Mode Register”; Changed hexadecimal format of reset values for registers TABSR, ONSF, and TRGSR to binary
		54	• Changed register name “External Interrupt Source Select Register i” in <b>Table 4.24</b> to “External Interrupt Request Source Select Register i”
1.20	Feb 6, 2013	69	• Modified register names “CAN0 Reception Error Count Register” and “CAN0 Transmission Error Count Register” in <b>Table 4.39</b> to “CAN0 Receive Error Count Register” and “CAN0 Transmit Error Count Register”, respectively
		79	<b>Chapter 5. Electrical Characteristics</b> • Changed expressions “CS0” and “A23 to A0, BC3 to BC0” in <b>Figure 5.5</b> to “Chip select” and “Address”, respectively
		111	<b>Appendix 1. Package Dimensions</b> • Added a seating plane to the drawing of package dimension
1.20	Feb 6, 2013	—	Fourth edition released
		—	This manual in general • Changed document number “REJ03B0254-0110” to “R01DS0064EJ0120” • Modified expressions “version N”, “version D”, and “version P” to “N version”, “D version”, and “P version”, respectively (under Chapters 1 and 5)

Revision History	R32C/117 Group Datasheet
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Rev.	Date	Description	
		Page	Summary
		<b>Chapter 1. Overview</b>	
		— 2, 4	<ul style="list-style-type: none"> <li>• Modified wording and enhanced description in this chapter</li> <li>• Modified expressions “Main clock oscillator stop/re-oscillation detection”, “calculation transfer”, “chained transfer”, and “inputs/ outputs” in <b>Tables 1.1 and 1.3</b> to “Main clock oscillator stop/restart detection”, “calculation result transfer”, “chain transfer”, and “I/O ports”, respectively</li> </ul>
		6	<ul style="list-style-type: none"> <li>• Completed “on planning” phase of part number R5F6417APFB in <b>Table 1.5</b></li> </ul>
		6, 7	<ul style="list-style-type: none"> <li>• Completed “under development” phase of versions D and P products in <b>Tables 1.5 and 1.6</b></li> </ul>
		10, 15	<ul style="list-style-type: none"> <li>• Changed order of signals in <b>Figures 1.3 and 1.4</b></li> </ul>
		11, 16	<ul style="list-style-type: none"> <li>• Changed order of timer pins “TB5IN/TA0IN” in <b>Tables 1.7 and 1.11</b> to “TA0IN/TB5IN”</li> </ul>
		21	<ul style="list-style-type: none"> <li>• Changed expression “I2C bus” in <b>Table 1.16</b> to “I2C-bus”</li> </ul>
		23	<ul style="list-style-type: none"> <li>• Modified Note 1 of <b>Table 1.18</b></li> </ul>
		<b>Chapter 2. CPU</b>	
		— 25	<ul style="list-style-type: none"> <li>• Modified wording and enhanced description in this chapter</li> <li>• Corrected a typo “R3R0” in line 3 of <b>2.1.1</b> to “R3R1”</li> </ul>
		<b>Chapter 3. Memory</b>	
		—	<ul style="list-style-type: none"> <li>• Modified wording and enhanced description in this chapter</li> </ul>
		<b>Chapter 4. SFRs</b>	
		— 34, 35, 37	<ul style="list-style-type: none"> <li>• Changed expressions “I2C Bus” and “I2C-Bus” to “I2C-bus”</li> <li>• Changed hexadecimal format of reset values for registers G1BCR0, G2BCR0, and G0BCR0 in <b>Tables 4.6, 4.7, and 4.9</b> to binary</li> </ul>
		41	<ul style="list-style-type: none"> <li>• Changed register name “Increment/Decrement Counting Select Register” in <b>Table 4.13</b> to “Increment/Decrement Select Register”</li> </ul>
		43	<ul style="list-style-type: none"> <li>• Corrected reset value “X00X X000b” for AD0CON2 register in <b>Table 4.15</b> to “XX0X X000b”</li> </ul>
		53	<ul style="list-style-type: none"> <li>• Modified register name “I2C Bus START Condition/STOP Condition Control Register” in <b>Table 4.25</b> to “I2C-bus START and STOP Conditions Control Register”; Corrected reset values for the following registers in: I2CSSCR, I2CCR1, I2CCR2, I2CSR, and I2CMR</li> </ul>
		64, 65	<ul style="list-style-type: none"> <li>• Changed register name “CAN0 Acceptance Mask Register k” in <b>Tables 4.36 and 4.37</b> to “CAN0 Mask Register k”</li> </ul>
		67	<ul style="list-style-type: none"> <li>• Corrected reset value “XXXX XX00b” for C0MSMR register in <b>Table 4.39</b> to “0000 0000b”</li> </ul>
		<b>Chapter 5. Electrical Characteristics</b>	
		— 74	<ul style="list-style-type: none"> <li>• Modified wording and enhanced description in this chapter</li> <li>• Changed expression “Programming and erasure endurance of flash memory” in <b>Table 5.8</b> to “Program/erase cycles”; Changed its unit “times” to “Cycles”</li> </ul>
		79, 92	<ul style="list-style-type: none"> <li>• Added “MSCL” and “MSDA” to <b>Tables 5.16 and 5.42</b></li> </ul>
		80, 93	<ul style="list-style-type: none"> <li>• Modified description “Drive power” in <b>Tables 5.17 and 5.43</b> to “Drive strength”</li> </ul>
		86, 99	<ul style="list-style-type: none"> <li>• Corrected “INTi” in the title of <b>Tables 5.32 and 5.58</b> to “<math>\overline{\text{INTi}}</math>”</li> </ul>

## General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

### 1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

### 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

### 5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.